

# DATA SHEET

## **NE567/SE567**

Tone decoder/phase-locked loop

Product data  
Supersedes data of 1992 Apr 15

2002 Sep 25

# Tone decoder/phase-locked loop

# NE567/SE567

## DESCRIPTION

The NE567/SE567 tone and frequency decoder is a highly stable phase-locked loop with synchronous AM lock detection and power output circuitry. Its primary function is to drive a load whenever a sustained frequency within its detection band is present at the self-biased input. The bandwidth center frequency and output delay are independently determined by means of four external components.

## PIN CONFIGURATION

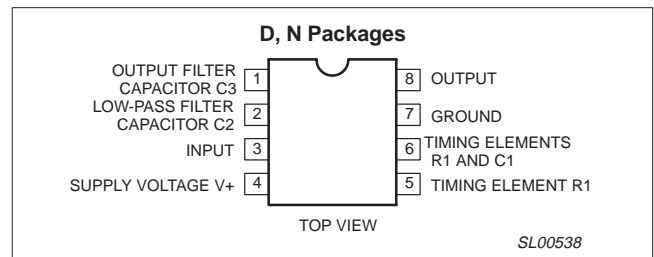


Figure 1. Pin configuration

## FEATURES

- Wide frequency range (0.01 Hz to 500 kHz)
- High stability of center frequency
- Independently controllable bandwidth (up to 14%)
- High out-band signal and noise rejection
- Logic-compatible output with 100 mA current sinking capability
- Inherent immunity to false signals
- Frequency adjustment over a 20-to-1 range with an external resistor

## APPLICATIONS

- Touch-Tone® decoding
- Carrier current remote controls
- Ultrasonic controls (remote TV, etc.)
- Communications paging
- Frequency monitoring and control
- Wireless intercom
- Precision oscillator

## BLOCK DIAGRAM

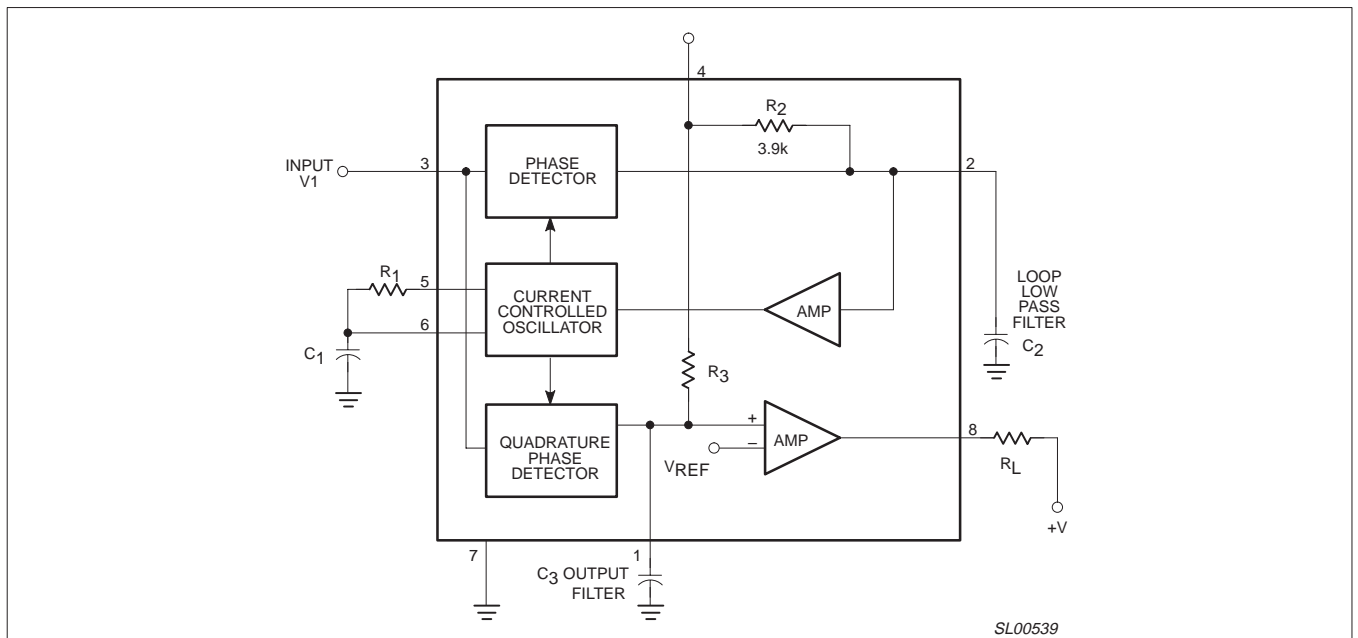


Figure 2. Block Diagram

®Touch-Tone is a registered trademark of AT&T.

# Tone decoder/phase-locked loop

# NE567/SE567

## EQUIVALENT SCHEMATIC

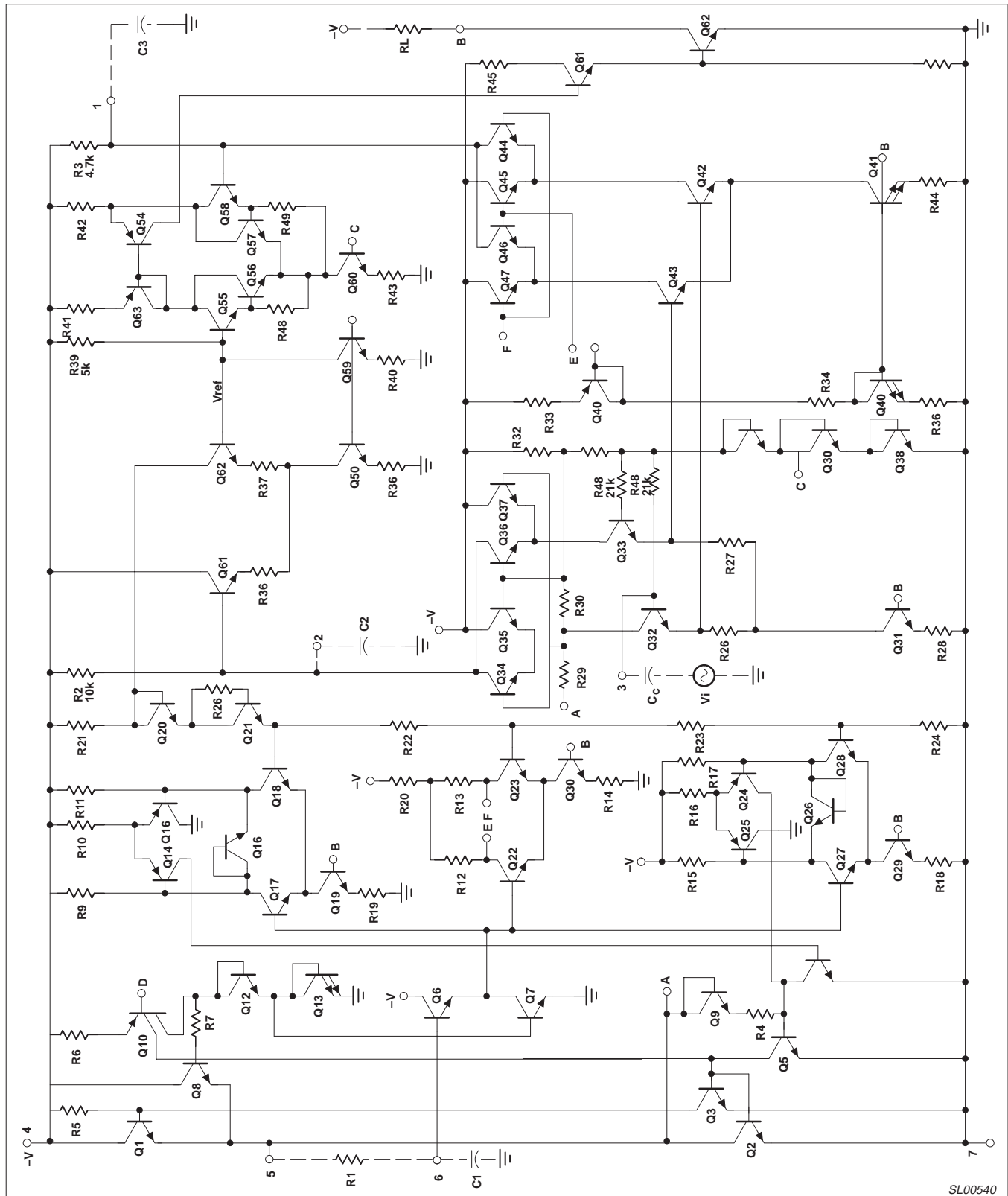


Figure 3. Equivalent schematic

SL00540

## Tone decoder/phase-locked loop

NE567/SE567

## ORDERING INFORMATION

ORDER CODE	DESCRIPTION	TEMPERATURE RANGE	DWG #
NE567D	SO8: plastic small outline package; 8 leads; body width 3.9 mm	0 °C to +70 °C	SOT96-1
NE567N	DIP8: plastic dual in-line package; 8 leads (300 mil)	0 °C to +70 °C	SOT97-1
SE567D	SO8: plastic small outline package; 8 leads; body width 3.9 mm	-55 °C to +125 °C	SOT96-1
SE567N	DIP8: plastic dual in-line package; 8 leads (300 mil)	-55 °C to +125 °C	SOT97-1

## ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RATING	UNIT
T <sub>amb</sub>	Operating temperature NE567 SE567	0 to +70	°C
		-55 to +125	°C
V <sub>CC</sub>	Operating voltage	10	V
V <sub>+</sub>	Positive voltage at input	0.5 +V <sub>S</sub>	V
V <sub>-</sub>	Negative voltage at input	-10	V <sub>DC</sub>
V <sub>OUT</sub>	Output voltage (collector of output transistor)	15	V <sub>DC</sub>
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C
P <sub>D</sub>	Power dissipation	300	mW

## Tone decoder/phase-locked loop

## NE567/SE567

**DC ELECTRICAL CHARACTERISTICS**V+ = 5.0 V; T<sub>amb</sub> = 25 °C, unless otherwise specified.

SYMBOL	PARAMETER	TEST CONDITIONS	SE567			NE567			UNIT
			Min	Typ	Max	Min	Typ	Max	
<b>Center frequency<sup>1</sup></b>									
f <sub>O</sub>	Highest center frequency			500			500		kHz
f <sub>O</sub>	Center frequency stability <sup>2</sup>	-55 °C to +125 °C 0 °C to +70 °C		35 ±140 35 ±60			35 ±140 35 ±60		ppm/°C ppm/°C
f <sub>O</sub>	Center frequency distribution	$f_O = 100\text{kHz} = \frac{1}{1.1R_1C_1}$	-10	0	+10	-10	0	+10	%
f <sub>O</sub>	Center frequency shift with supply voltage	$f_O = 100\text{kHz} = \frac{1}{1.1R_1C_1}$		0.5	1		0.7	2	%/V
<b>Detection bandwidth</b>									
BW	Largest detection bandwidth	$f_O = 100\text{kHz} = \frac{1}{1.1R_1C_1}$	12	14	16	10	14	18	% of f <sub>O</sub>
BW	Largest detection bandwidth skew			2	4		3	6	% of f <sub>O</sub>
BW	Largest detection bandwidth—variation with temperature	V <sub>I</sub> = 300 mV <sub>RMS</sub>		±0.1			±0.1		%/°C
BW	Largest detection bandwidth—variation with supply voltage	V <sub>I</sub> = 300 mV <sub>RMS</sub>		±2			±2		%/V
<b>Input</b>									
R <sub>IN</sub>	Input resistance		15	20	25	15	20	25	kΩ
V <sub>I</sub>	Smallest detectable input voltage <sup>4</sup>	I <sub>L</sub> = 100 mA; f <sub>I</sub> = f <sub>O</sub>		20	25		20	25	mV <sub>RMS</sub>
	Largest no-output input voltage <sup>4</sup>	I <sub>L</sub> = 100 mA; f <sub>I</sub> = f <sub>O</sub>	10	15		10	15		mV <sub>RMS</sub>
	Greatest simultaneous out-band signal-to-in-band signal ratio			+6			+6		dB
	Minimum input signal to wide-band noise ratio	B <sub>n</sub> = 140 kHz		-6			-6		dB
<b>Output</b>									
	Fastest on-off cycling rate			f <sub>O</sub> /20			f <sub>O</sub> /20		
	"1" output leakage current	V <sub>g</sub> = 15 V		0.01	25		0.01	25	μA
	"0" output voltage	I <sub>L</sub> = 30 mA I <sub>L</sub> = 100 mA		0.2	0.4		0.2	0.4	V
				0.6	1.0		0.6	1.0	V
t <sub>F</sub>	Output fall time <sup>3</sup>	R <sub>L</sub> = 50 Ω		30			30		ns
t <sub>R</sub>	Output rise time <sup>3</sup>	R <sub>L</sub> = 50 Ω		150			150		ns
<b>General</b>									
V <sub>CC</sub>	Operating voltage range		4.75		9.0	4.75		9.0	V
	Supply current quiescent			6	8		7	10	mA
	Supply current—activated	R <sub>L</sub> = 20 kΩ		11	13		12	15	mA
t <sub>PD</sub>	Quiescent power dissipation			30			35		mW

**NOTES:**

- Frequency determining resistor R<sub>1</sub> should be between 2 and 20 kΩ
- Applicable over 4.75 V to 5.75 V. See graphs for more detailed information.
- Pin 8 to Pin 1 feedback R<sub>L</sub> network selected to eliminate pulsing during turn-on and turn-off.
- With R<sub>2</sub> = 130 kΩ from Pin 1 to V+. See Figure 16.

# Tone decoder/phase-locked loop

# NE567/SE567

## TYPICAL PERFORMANCE CHARACTERISTICS

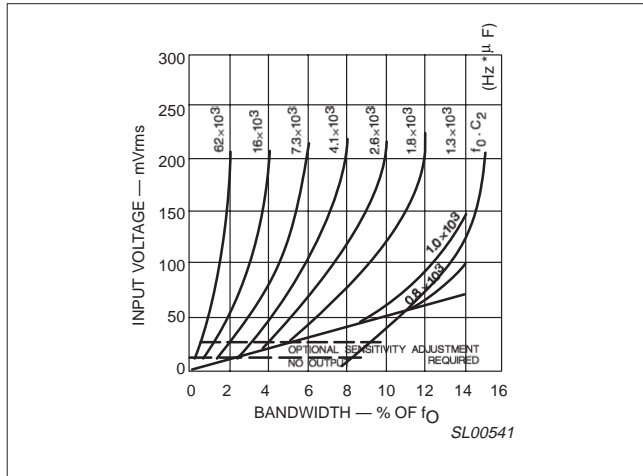


Figure 4. Bandwidth vs. input signal amplitude

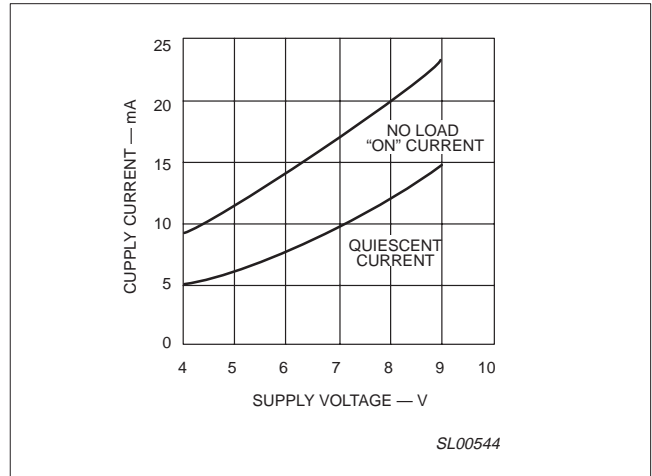


Figure 7. Typical supply current vs. supply voltage

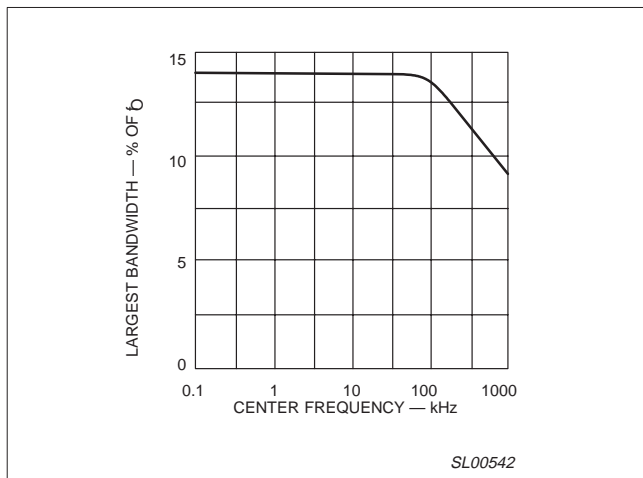


Figure 5. Largest detection bandwidth vs. operating frequency

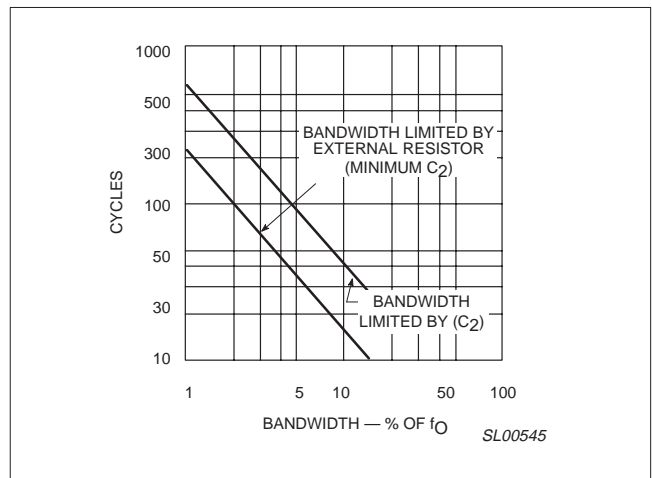


Figure 8. Greatest number of cycles before output

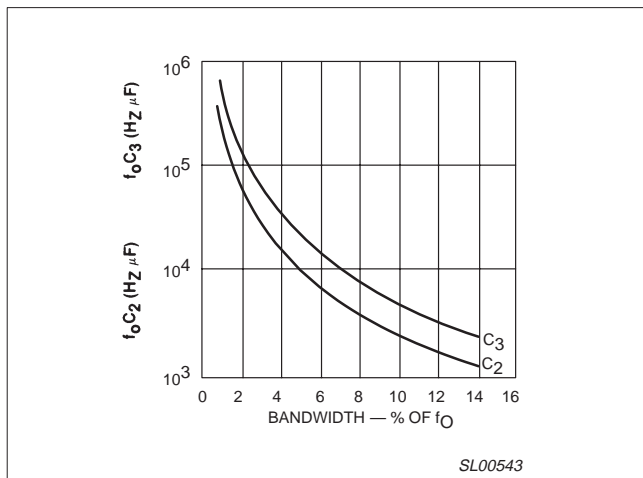


Figure 6. Detection bandwidth as a function of  $C_2$  and  $C_3$

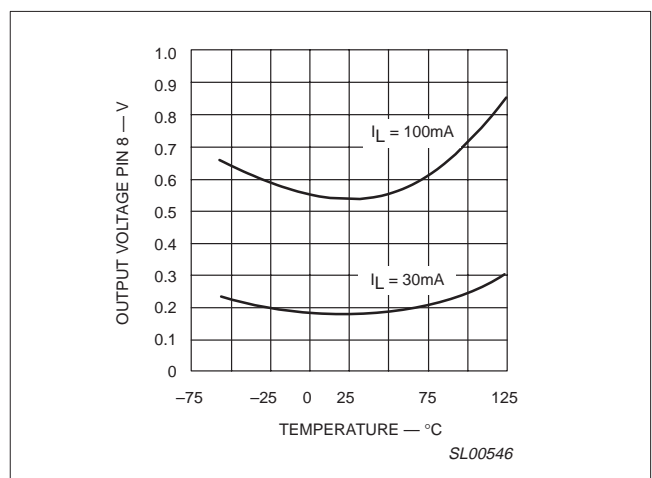


Figure 9. Typical output voltage vs. temperature

Tone decoder/phase-locked loop

NE567/SE567

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

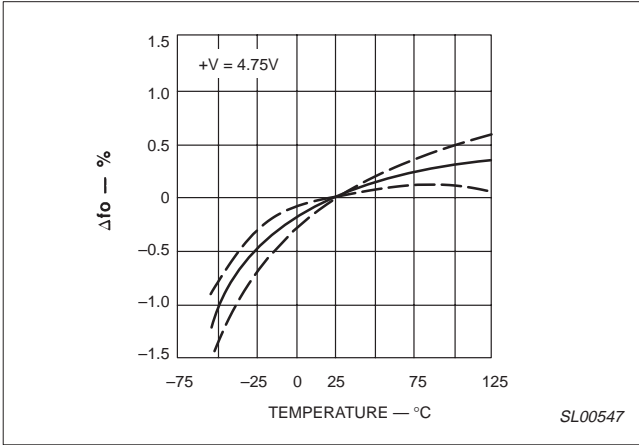


Figure 10. Typical frequency drift with temperature (Mean and SD)

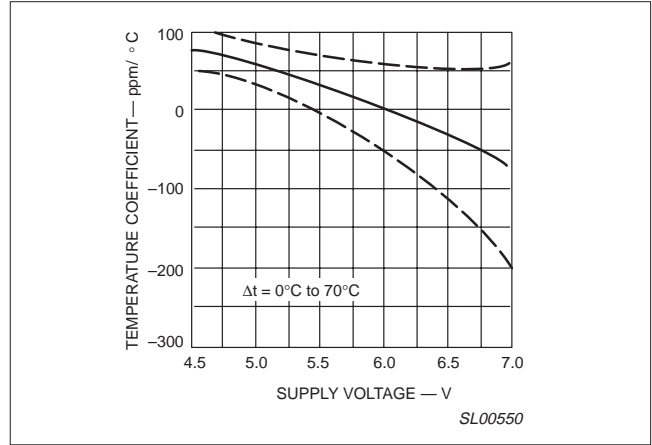


Figure 13. Center frequency temperature coefficient (Mean and SD)

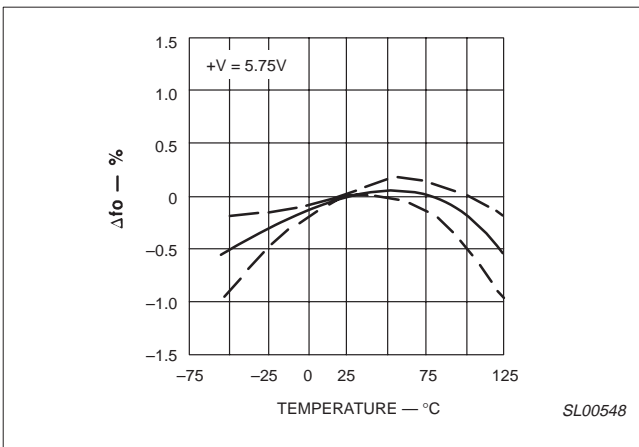


Figure 11. Typical frequency drift with temperature (Mean and SD)

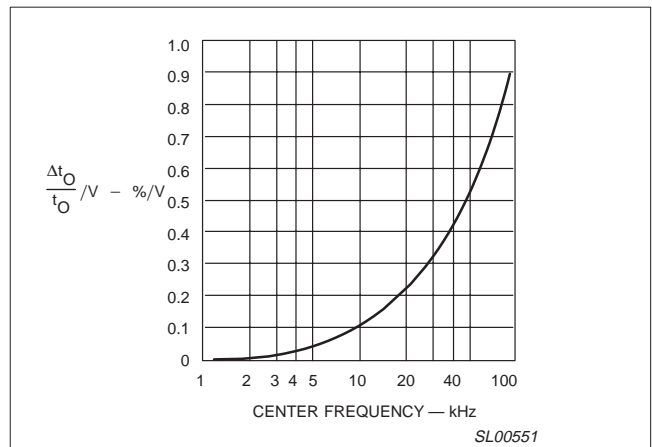


Figure 14. Center frequency shift with supply voltage change vs. operating frequency

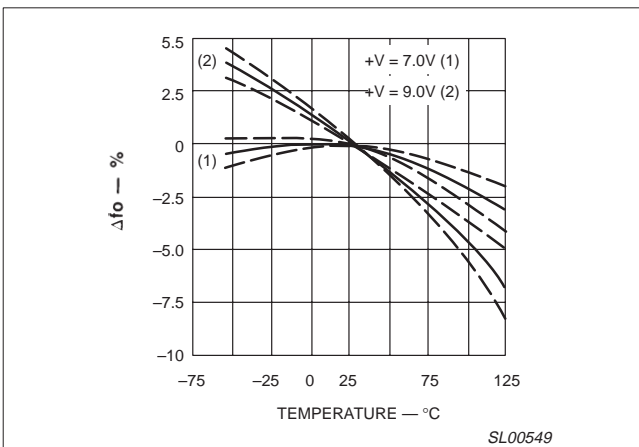


Figure 12. Typical frequency drift with temperature (Mean and SD)

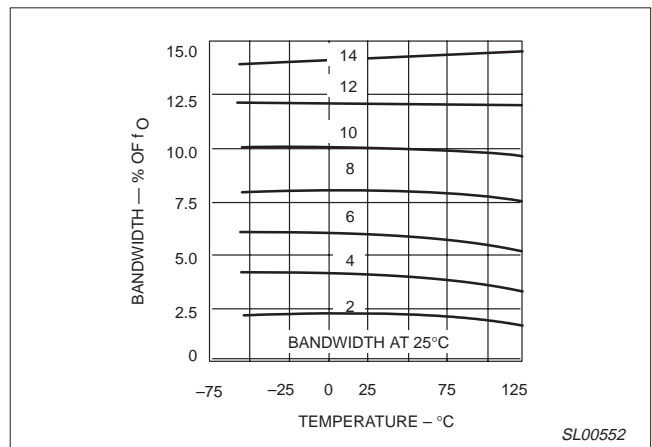


Figure 15. Typical bandwidth variation temperature

# Tone decoder/phase-locked loop

# NE567/SE567

## DESIGN FORMULAS

$$f_o \approx \frac{1}{1.1R_1 C_1}$$

$$BW \approx 1070 \sqrt{\frac{V_1}{f_o C_2}} \text{ in \% of } f_o$$

$$V_1 \leq 200mV_{RMS}$$

Where

$V_1$  = Input voltage ( $V_{RMS}$ )

$C_2$  = Low-pass filter capacitor ( $\mu F$ )

## PHASE-LOCKED LOOP TERMINOLOGY CENTER FREQUENCY ( $f_o$ )

The free-running frequency of the current controlled oscillator (CCO) in the absence of an input signal.

## Detection bandwidth (BW)

The frequency range, centered about  $f_o$ , within which an input signal above the threshold voltage (typically 20 mV<sub>RMS</sub>) will cause a logical zero state on the output. The detection bandwidth corresponds to the loop capture range.

## Lock range

The largest frequency range within which an input signal above the threshold voltage will hold a logical zero state on the output.

## Detection band skew

A measure of how well the detection band is centered about the center frequency,  $f_o$ . The skew is defined as:

$$\frac{(f_{MAX} + f_{MIN} - 2f_o)}{2f_o}$$

where  $f_{MAX}$  and  $f_{MIN}$  are the frequencies corresponding to the edges of the detection band. The skew can be reduced to zero if necessary by means of an optional centering adjustment.

## OPERATING INSTRUCTIONS

Figure 16 shows a typical connection diagram for the 567. For most applications, the following three-step procedure will be sufficient for choosing the external components  $R_1$ ,  $C_1$ ,  $C_2$  and  $C_3$ .

1. Select  $R_1$  and  $C_1$  for the desired center frequency. For best temperature stability,  $R_1$  should be between 2 k $\Omega$  and 20 k $\Omega$ , and the combined temperature coefficient of the  $R_1C_1$  product should have sufficient stability over the projected temperature range to meet the necessary requirements.
2. Select the low-pass capacitor,  $C_2$ , by referring to Figure 4, 'Bandwidth vs. input signal amplitude'. If the input amplitude variation is known, the appropriate value of  $f_o \cdot C_2$  necessary to give the desired bandwidth may be found. Conversely, an area of operation may be selected on this graph and the input level and  $C_2$  may be adjusted accordingly. For example, constant bandwidth operation requires that input amplitude be above 200mV<sub>RMS</sub>. The bandwidth, as noted on the graph, is then controlled solely by the  $f_o \cdot C_2$  product ( $f_o$  (Hz),  $C_2(\mu F)$ ).

3. The value of  $C_3$  is generally non-critical.  $C_3$  sets the band edge of a low-pass filter which attenuates frequencies outside the detection band to eliminate spurious outputs. If  $C_3$  is too small, frequencies just outside the detection band will switch the output stage on and off at the beat frequency, or the output may pulse on and off during the turn-on transient. If  $C_3$  is too large, turn-on and turn-off of the output stage will be delayed until the voltage on  $C_3$  passes the threshold voltage. (Such delay may be desirable to avoid spurious outputs due to transient frequencies.) A typical minimum value for  $C_3$  is  $2C_2$ .

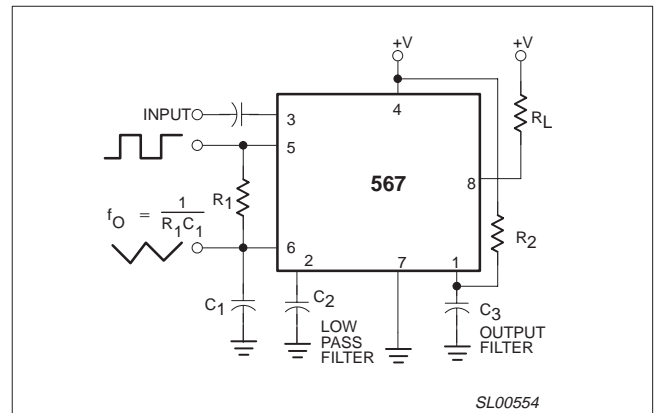


Figure 16. Typical connection

4. Optional resistor  $R_2$  sets the threshold for the largest "no output" input voltage. A value of 130 k $\Omega$  is used to assure the tested limit of 10 mV<sub>RMS</sub> min. This resistor can be referenced to ground for increased sensitivity. The explanation can be found in the "optional controls" section which follows.

## TYPICAL RESPONSE

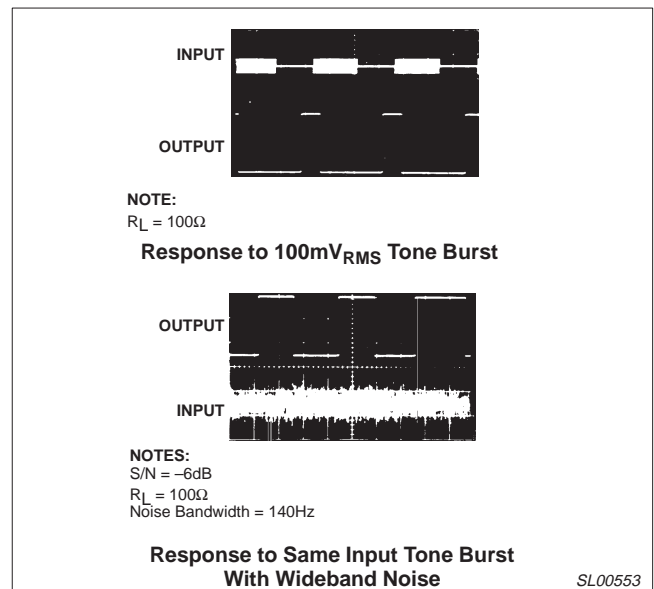


Figure 17. Typical response



# Tone decoder/phase-locked loop

# NE567/SE567

## AVAILABLE OUTPUTS (Figure 18)

The primary output is the uncommitted output transistor collector, Pin 8. When an in-band input signal is present, this transistor saturates; its collector voltage being less than 1.0 volt (typically 0.6V) at full output current (100mA). The voltage at Pin 2 is the phase detector output which is a linear function of frequency over the range of  $0.95$  to  $1.05 f_O$  with a slope of about 20mV per percent of frequency deviation. The average voltage at Pin 1 is, during lock, a function of the in-band input amplitude in accordance with the transfer characteristic given. Pin 5 is the controlled oscillator square wave output of magnitude  $(+V - 2V_{BE}) \cong (+V - 1.4V)$  having a DC average of  $+V/2$ . A  $1k\Omega$  load may be driven from pin 5. Pin 6 is an exponential triangle of  $1V_{P-P}$  with an average DC level of  $+V/2$ . Only high impedance loads may be connected to pin 6 without affecting the CCO duty cycle or temperature stability.

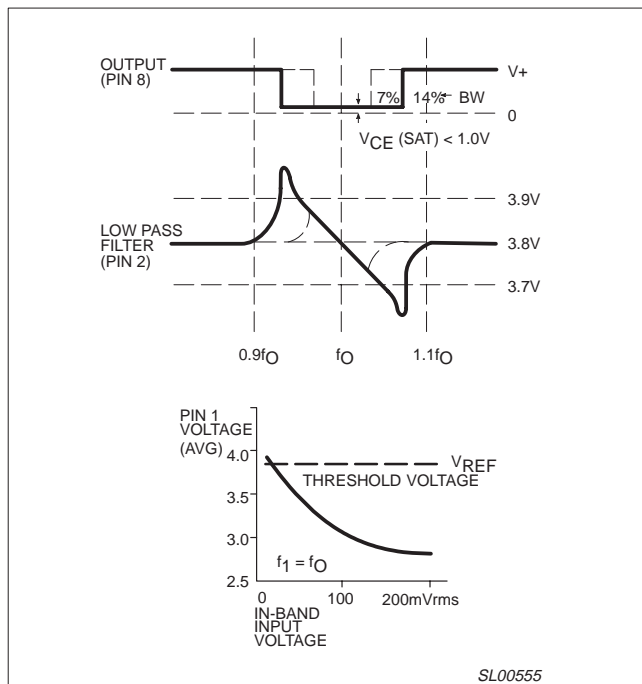


Figure 18. Available outputs

## OPERATING PRECAUTIONS

A brief review of the following precautions will help the user achieve the high level of performance of which the 567 is capable.

1. Operation in the high input level mode (above 200 mV) will free the user from bandwidth variations due to changes in the in-band signal amplitude. The input stage is now limiting, however, so that out-band signals or high noise levels can cause an apparent bandwidth reduction as the inband signal is suppressed. Also, the limiting action will create in-band components from sub-harmonic signals, so the 567 becomes sensitive to signals at  $f_O/3$ ,  $f_O/5$ , etc.
2. The 567 will lock onto signals near  $(2n+1) f_O$ , and will give an output for signals near  $(4n+1) f_O$  where  $n = 0, 1, 2$ , etc. Thus, signals at  $5f_O$  and  $9f_O$  can cause an unwanted output. If such signals are anticipated, they should be attenuated before reaching the 567 input.
3. Maximum immunity from noise and out-band signals is afforded in the low input level (below 200 mV<sub>RMS</sub>) and reduced bandwidth operating mode. However, decreased loop damping causes the worst-case lock-up time to increase, as shown by the Greatest Number of Cycles Before Output vs Bandwidth graph.
4. Due to the high switching speeds (20 ns) associated with 567 operation, care should be taken in lead routing. Lead lengths should be kept to a minimum. The power supply should be adequately bypassed close to the 567 with a 0.01μF or greater capacitor; grounding paths should be carefully chosen to avoid ground loops and unwanted voltage variations. Another factor which must be considered is the effect of load energization on the power supply. For example, an incandescent lamp typically draws 10 times rated current at turn-on. This can cause supply voltage fluctuations which could, for example, shift the detection band of narrow-band systems sufficiently to cause momentary loss of lock. The result is a low-frequency oscillation into and out of lock. Such effects can be prevented by supplying heavy load currents from a separate supply or increasing the supply filter capacitor.

# Tone decoder/phase-locked loop

# NE567/SE567

## SPEED OF OPERATION

Minimum lock-up time is related to the natural frequency of the loop. The lower it is, the longer becomes the turn-on transient. Thus, maximum operating speed is obtained when  $C_2$  is at a minimum. When the signal is first applied, the phase may be such as to initially drive the controlled oscillator away from the incoming frequency rather than toward it. Under this condition, which is of course unpredictable, the lock-up transient is at its worst and the theoretical minimum lock-up time is not achievable. We must simply wait for the transient to die out.

The following expressions give the values of  $C_2$  and  $C_3$  which allow highest operating speeds for various band center frequencies. The minimum rate at which digital information may be detected without information loss due to the turn-on transient or output chatter is about 10 cycles per bit, corresponding to an information transfer rate of  $f_O/10$  baud.

$$C_2 = \frac{130}{f_O} \mu\text{F}$$

$$C_3 = \frac{260}{f_O} \mu\text{F}$$

In cases where turn-off time can be sacrificed to achieve fast turn-on, the optional sensitivity adjustment circuit can be used to move the quiescent  $C_3$  voltage lower (closer to the threshold voltage). However, sensitivity to beat frequencies, noise and extraneous signals will be increased.

## OPTIONAL CONTROLS (Figure 19)

The 567 has been designed so that, for most applications, no external adjustments are required. Certain applications, however, will be greatly facilitated if full advantage is taken of the added control possibilities available through the use of additional external components. In the diagrams given, typical values are suggested where applicable. For best results the resistors used, except where noted, should have the same temperature coefficient. Ideally, silicon diodes would be low-resistivity types, such as forward-biased transistor base-emitter junctions. However, ordinary low-voltage diodes should be adequate for most applications.

## SENSITIVITY ADJUSTMENT (Figure 19)

When operated as a very narrow-band detector (less than 8%), both  $C_2$  and  $C_3$  are made quite large in order to improve noise and out-band signal rejection. This will inevitably slow the response time. If, however, the output stage is biased closer to the threshold level, the turn-on time can be improved. This is accomplished by drawing additional current to terminal 1. Under this condition, the 567 will also give an output for lower-level signals (10 mV or lower).

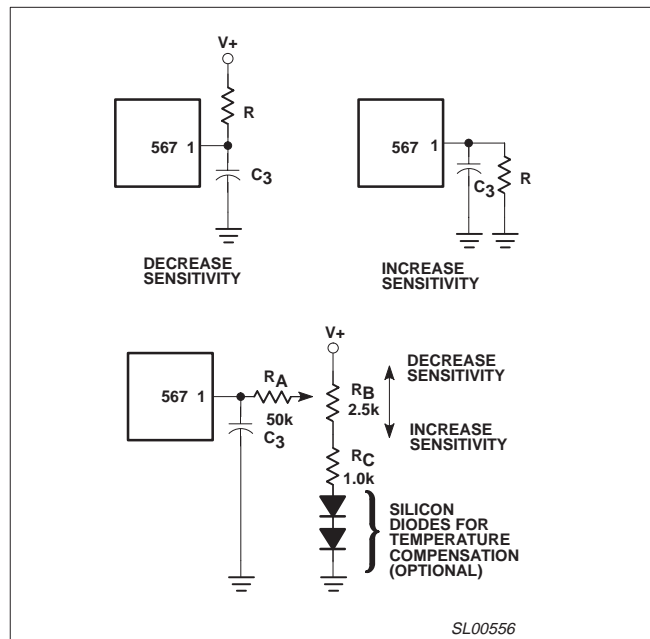


Figure 19. Sensitivity adjustment

By adding current to terminal 1, the output stage is biased further away from the threshold voltage. This is most useful when, to obtain maximum operating speed,  $C_2$  and  $C_3$  are made very small. Normally, frequencies just outside the detection band could cause false outputs under this condition. By desensitizing the output stage, the out-band beat notes do not feed through to the output stage. Since the input level must be somewhat greater when the output stage is made less sensitive, rejection of third harmonics or in-band harmonics (of lower frequency signals) is also improved.

# Tone decoder/phase-locked loop

# NE567/SE567

## CHATTER PREVENTION (Figure 20)

Chatter occurs in the output stage when  $C_3$  is relatively small, so that the lock transient and the AC components at the quadrature phase detector (lock detector) output cause the output stage to move through its threshold more than once. Many loads, for example lamps and relays, will not respond to the chatter. However, logic may recognize the chatter as a series of outputs. By feeding the output stage output back to its input (Pin 1) the chatter can be eliminated. Three schemes for doing this are given in Figure 20. All operate by feeding the first output step (either on or off) back to the input, pushing the input past the threshold until the transient conditions are over. It is only necessary to assure that the feedback time constant is not so large as to prevent operation at the highest anticipated speed. Although chatter can always be eliminated by making  $C_3$  large, the feedback circuit will enable faster operation of the 567 by allowing  $C_3$  to be kept small. Note that if the feedback time constant is made quite large, a short burst in the input frequency can be stretched into a long output pulse. This may be useful to drive, for example, stepping relays.

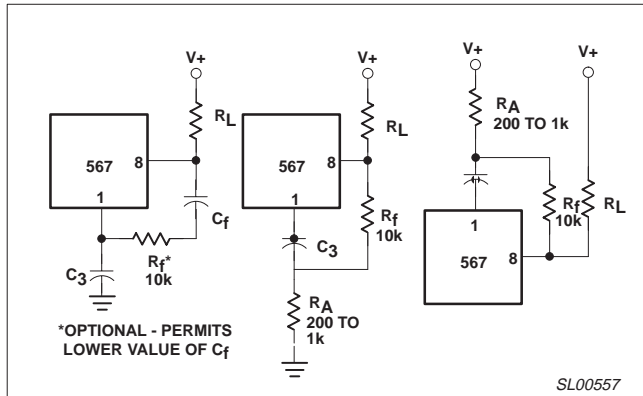


Figure 20. Chatter prevention

## DETECTION BAND CENTERING (OR SKEW) ADJUSTMENT (Figure 21)

When it is desired to alter the location of the detection band (corresponding to the loop capture range) within the lock range, the circuits shown above can be used. By moving the detection band to one edge of the range, for example, input signal variations will expand the detection band in only one direction. This may prove useful when a strong but undesirable signal is expected on one side or the other of the center frequency. Since  $R_B$  also alters the duty cycle slightly, this method may be used to obtain a precise duty cycle when the 567 is used as an oscillator.

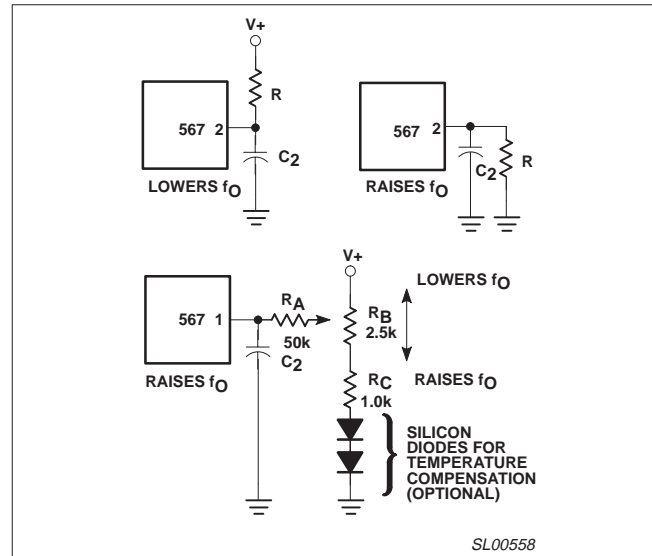


Figure 21. Skew adjust

# Tone decoder/phase-locked loop

# NE567/SE567

## ALTERNATE METHOD OF BANDWIDTH REDUCTION (Figure 22)

Although a large value of  $C_2$  will reduce the bandwidth, it also reduces the loop damping so as to slow the circuit response time. This may be undesirable. Bandwidth can be reduced by reducing the loop gain. This scheme will improve damping and permit faster operation under narrow-band conditions. Note that the reduced impedance level at terminal 2 will require that a larger value of  $C_2$  be used for a given filter cutoff frequency. If more than three 567s are to be used, the network of  $R_B$  and  $R_C$  can be eliminated and the  $R_A$  resistors connected together. A capacitor between this junction and ground may be required to shunt high frequency components.

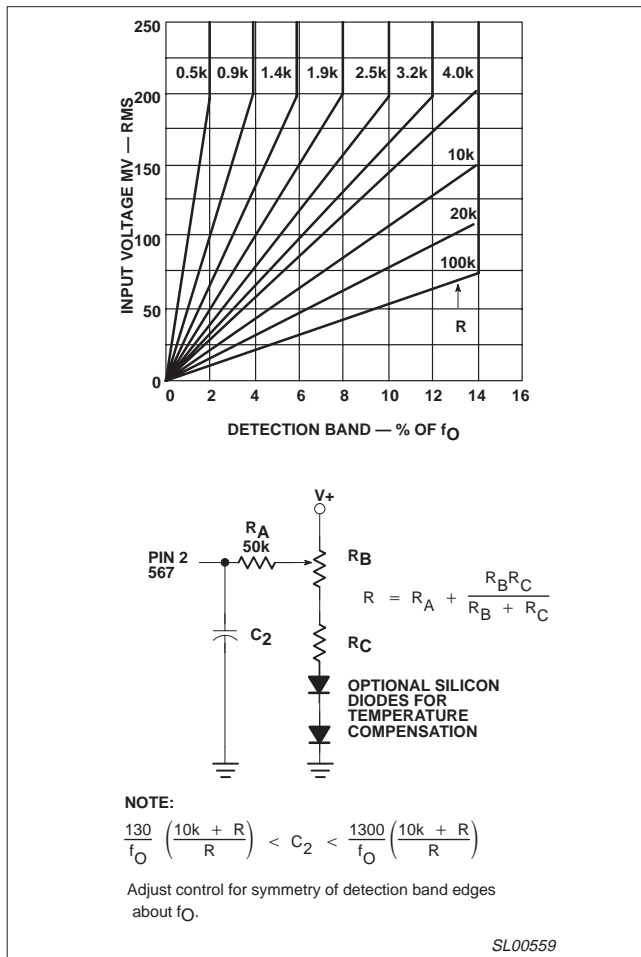


Figure 22. BW reduction

## OUTPUT LATCHING (Figure 23)

To latch the output on after a signal is received, it is necessary to provide a feedback resistor around the output stage (between Pins 8 and 1). Pin 1 is pulled-up to unlatch the output stage.

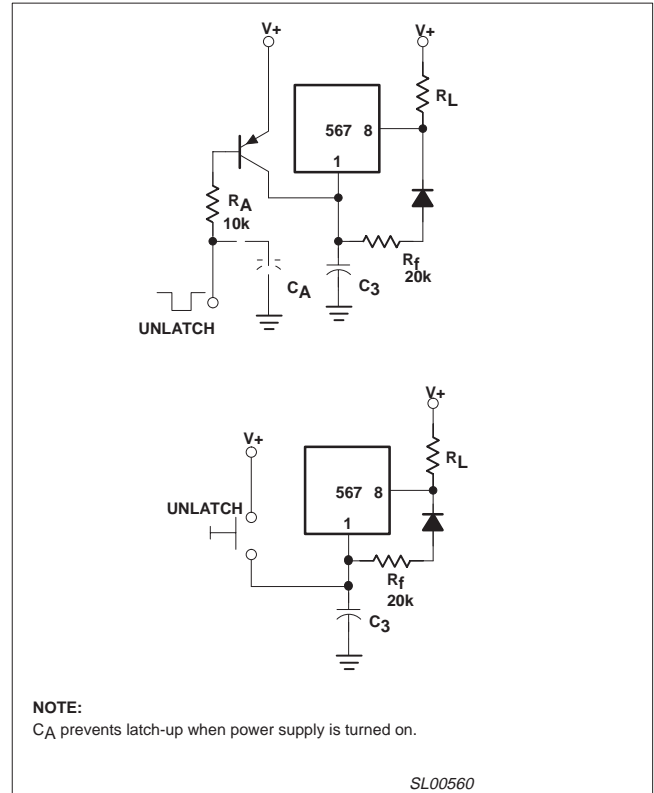


Figure 23. Output latching

## REDUCTION OF $C_1$ VALUE

For precision very low-frequency applications, where the value of  $C_1$  becomes large, an overall cost savings may be achieved by inserting a voltage-follower between the  $R_1$   $C_1$  junction and Pin 6, so as to allow a higher value of  $R_1$  and a lower value of  $C_1$  for a given frequency.

## PROGRAMMING

To change the center frequency, the value of  $R_1$  can be changed with a mechanical or solid state switch, or additional  $C_1$  capacitors may be added by grounding them through saturating NPN transistors.

# Tone decoder/phase-locked loop

# NE567/SE567

## TYPICAL APPLICATIONS

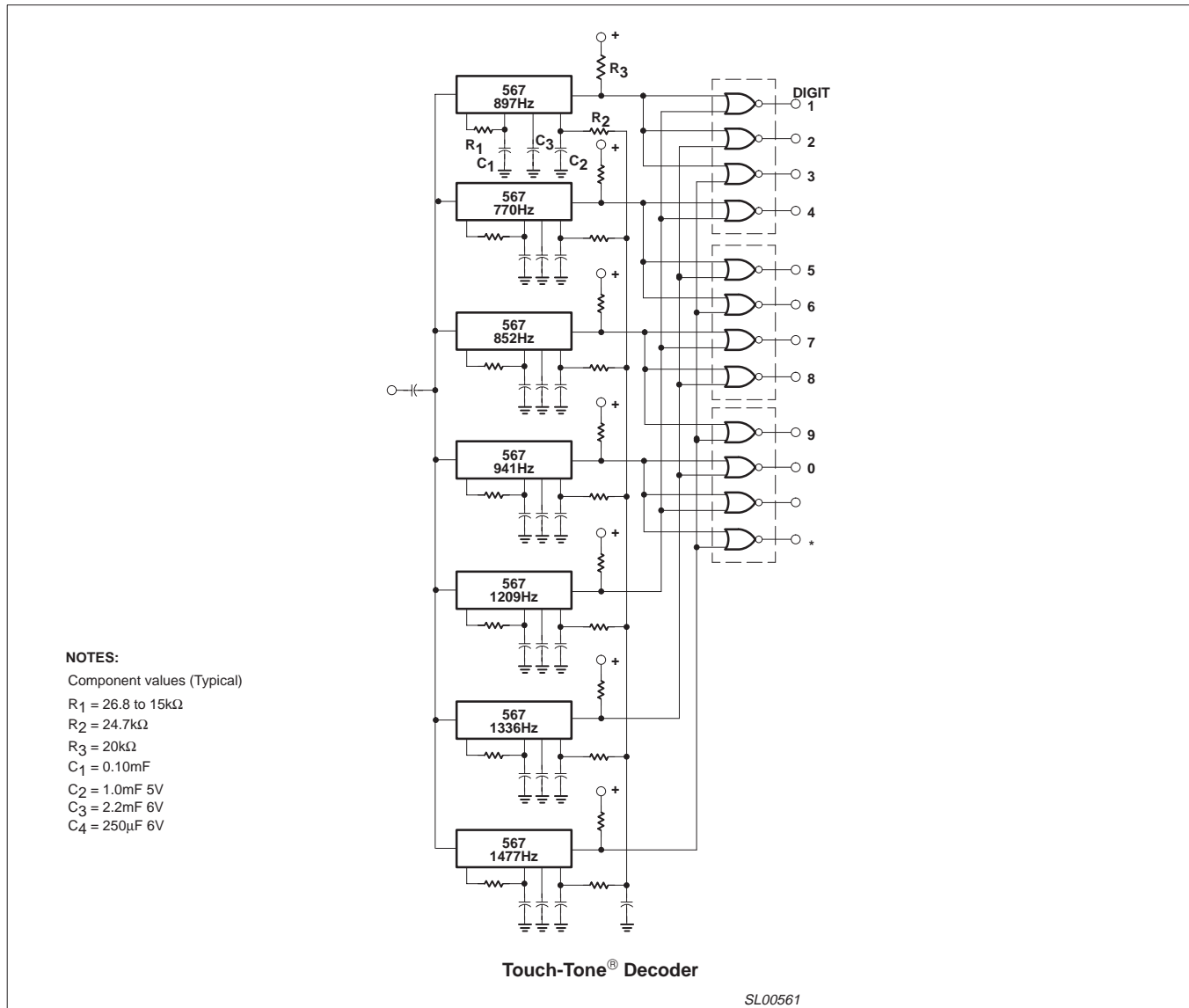


Figure 24. Typical applications

# Tone decoder/phase-locked loop

# NE567/SE567

## TYPICAL APPLICATIONS (continued)

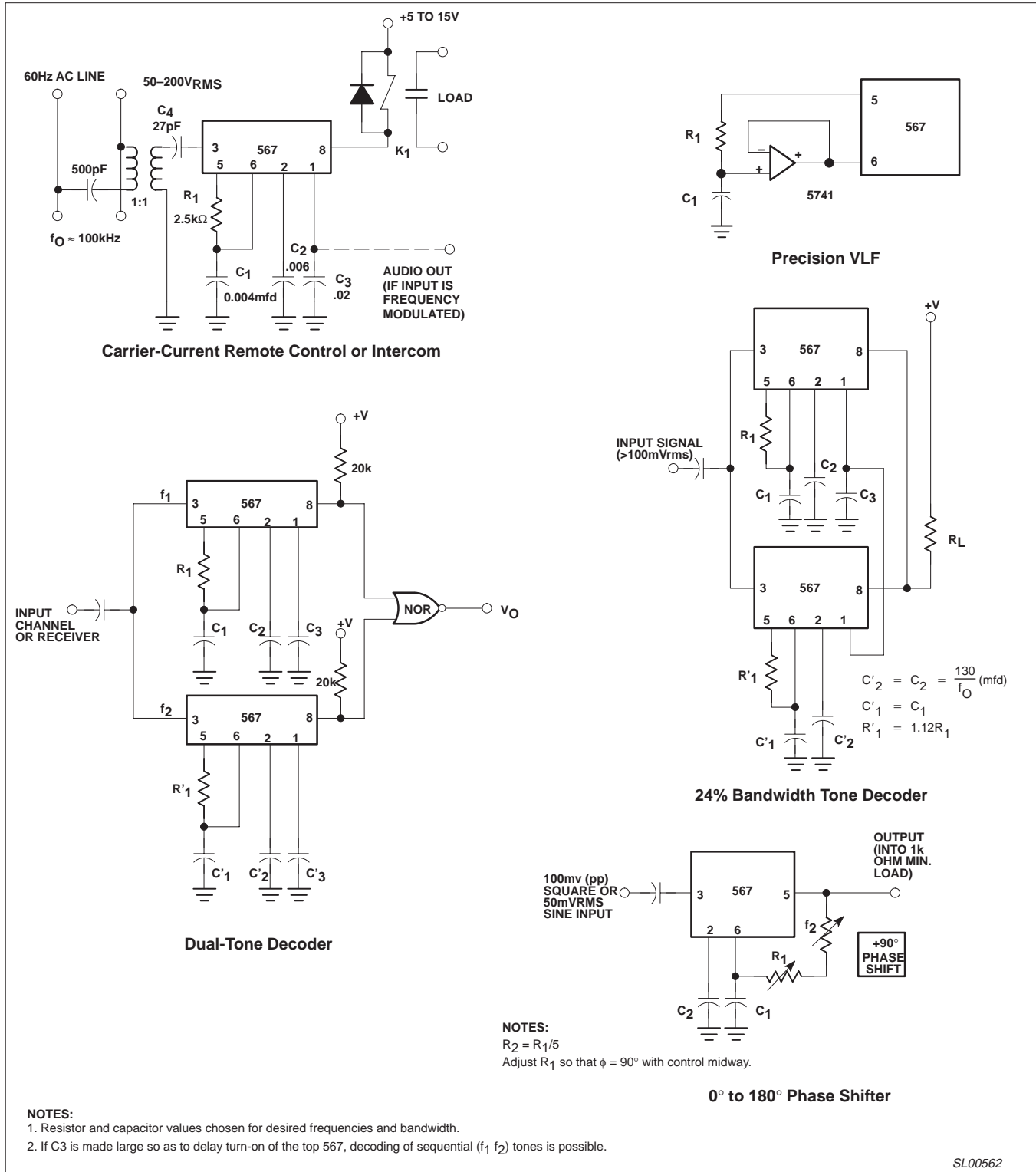


Figure 25. Typical applications (cont.)

Tone decoder/phase-locked loop

NE567/SE567

TYPICAL APPLICATIONS (continued)

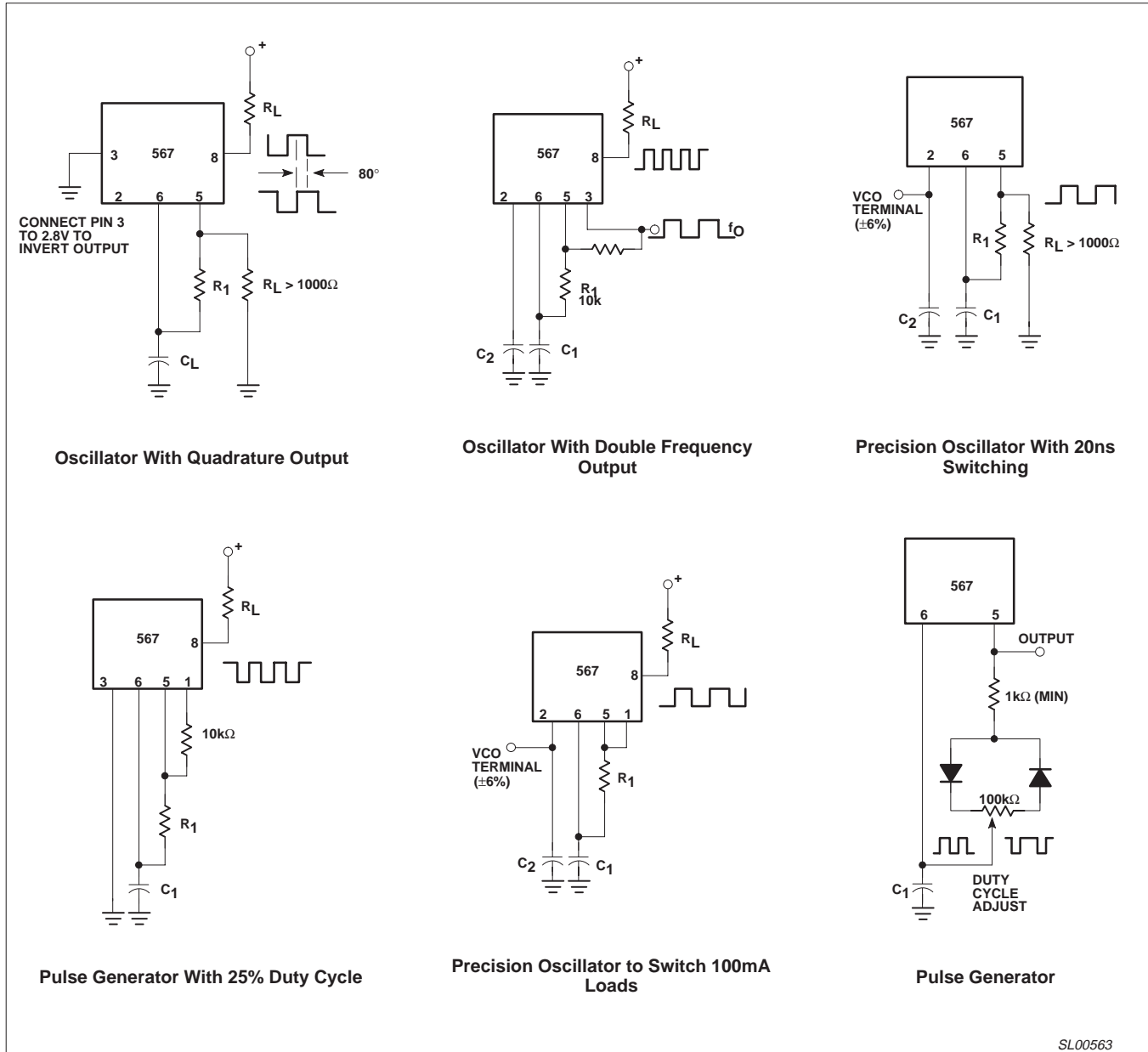


Figure 26. Typical applications (cont.)

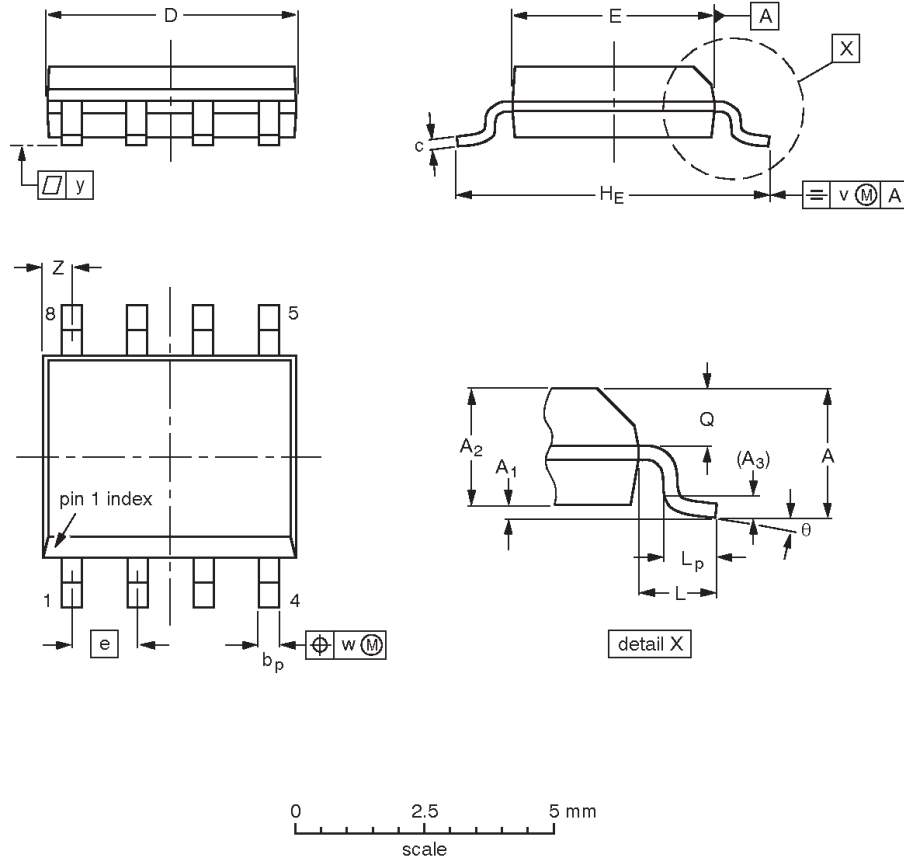
SL00563

Tone decoder/phase-locked loop

NE567/SE567

S08: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	HE	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	5.0 4.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.20 0.19	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT96-1	076E03	MS-012				97-05-22 99-12-27

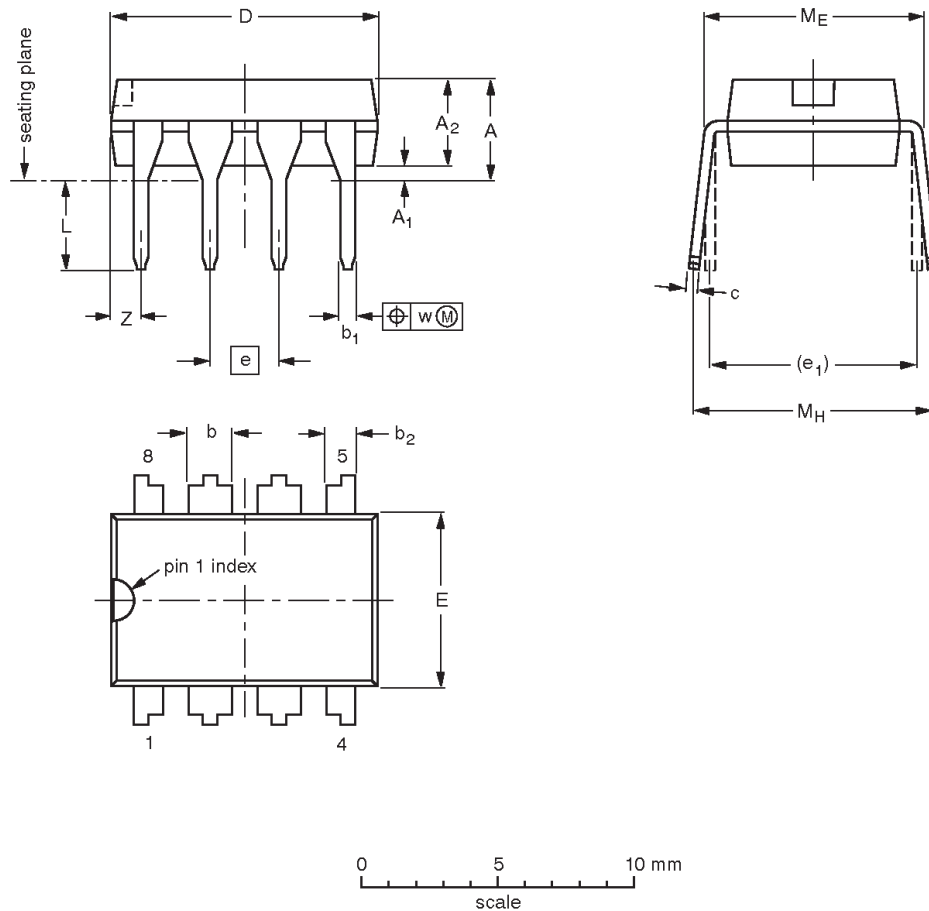


Tone decoder/phase-locked loop

NE567/SE567

DIP8: plastic dual in-line package; 8 leads (300 mil)

SOT97-1



**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.14	0.53 0.38	1.07 0.89	0.36 0.23	9.8 9.2	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	1.15
inches	0.17	0.020	0.13	0.068 0.045	0.021 0.015	0.042 0.035	0.014 0.009	0.39 0.36	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.045

**Note**

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT97-1	050G01	MO-001	SC-504-8			95-02-04 99-12-27

## Tone decoder/phase-locked loop

NE567/SE567

## Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

## Definitions

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Application information** — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

## Disclaimers

**Life support** — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

**Right to make changes** — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

## Contact information

For additional information please visit  
<http://www.semiconductors.philips.com>. Fax: +31 40 27 24825

© Koninklijke Philips Electronics N.V. 2002  
 All rights reserved. Printed in U.S.A.

Date of release: 09-02

For sales offices addresses send e-mail to:  
[sales.addresses@www.semiconductors.philips.com](mailto:sales.addresses@www.semiconductors.philips.com)

Document order number:

9397 750 10404

*Let's make things better.*